

Customer Information Notification

Issue Date: 02-Jun-2015 Effective Date: 17-Jul-2015

Here's your personalized quality information concerning products Digi-Key purchased from NXP.

For detailed information we invite you to view this notification online

2015050181



Management Summary

Discontinuation of delivery form tube and switch to tape and reel

Change Category

Wafer Fab process	[] Assembly Process	[] Product Marking	[] Design

[] Wafer Fab materials [] Assembly Materials [] Electrical spec./Test coverage [] Mechanical Specification [] Wafer Fab location [] Assembly Location [] Test Location [X] Packing/Shipping/Labeling

Discontinuation of delivery form tube and switch to tape and reel

Information Notification

We will stop the delivery of these products in tubes and continue the delivery as tape and reel.

Why do we issue this Information Notification

To streamline the packing variants and eliminate the ones not needed by customers.

Identification of Affected Products

Product identification does not change

Impact

no impact to the product's functionality anticipated.

Data Sheet Revision

A new datasheet will be issued

Contact and Support

For all inquiries regarding the ePCN tool application or access issues, please contact NXP "Global Quality Support Team".

For all Quality Notification content inquiries, please contact your local NXP Sales Support team.

For specific questions on this notice or the products affected please contact our specialist directly:

Name Cengiz Oezcan

Position Quality Manager PL CWG e-mail address Cengiz.Oezcan@nxp.com

At NXP Semiconductors we are constantly striving to improve our product and processes to ensure they reach the highest

possible Quality Standards.

Customer Focus, Passion to Win.

NXP Quality Management Team.

About NXP Semiconductors

NXP Semiconductors N.V. (NASDAQ: NXPI) provides High Performance Mixed Signal and Standard Product solutions that leverage its leading RF, Analog, Power Management, Interface, Security and Digital Processing expertise. These innovations are used in a wide range of automotive, identification, wireless infrastructure, lighting, industrial, mobile, consumer and computing applications.

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NXP Semiconductors

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Changed	Changed Part		New Orderable	
Orderable Part#	12NC	Package Outline	Part#	New part 12NC
PCF2100CT/F1,112	935195690112	SOT136-1	PCF2100CT/F1,118	935195690118
PCF2123BS/1,512	935286382512	SOT758-1	PCF2123BS/1,518	935286382518
PCF2123BS/1,512	935286382512	SOT758-1	PCF2123BS/1,518	935286382518
PCF8563T/F4,112	935262217112	SOT96-1	PCF8563T/F4,118	935262217118
PCF8563T/F4,112	935262217112	SOT96-1	PCF8563T/F4,118	935262217118
PCF8566T/1,112	935278688112	SOT158-1	PCF8566T/1,118	935278688118
PCF8583T/5,512	935276539512	SOT176-1	PCF8583T/5,518	935276539518
PCF8583T/5,512	935276539512	SOT176-1	PCF8583T/5,518	935276539518
PCF8591T/2,512	935276541512	SOT162-1	PCF8591T/2,518	935276541518
PCF8593T/1,112	935275723112	SOT96-1	PCF8593T/1,118	935275723118
PCF8593T/1,112	935275723112	SOT96-1	PCF8593T/1,118	935275723118